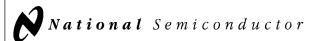
20 ns max



# LM160/LM360 High Speed Differential Comparator **General Description**

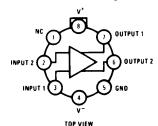
The LM160/LM360 is a very high speed differential input, complementary TTL output voltage comparator with improved characteristics over the  $\mu$ A760/ $\mu$ A760C, for which it is a pin-for-pin replacement. The device has been optimized for greater speed, input impedance and fan-out, and lower input offset voltage. Typically delay varies only 3 ns for overdrive variations of 5 mV to 400 mV.

Complementary outputs having minimum skew are provided. Applications involve high speed analog to digital convertors and zero-crossing detectors in disk file systems.

- Guaranteed high speed
- Tight delay matching on both outputs
- Complementary TTL outputs
- High input impedance
- Low speed variation with overdrive variation
- Fan-out of 4
- Low input offset voltage
- Series 74 TTL compatible

## **Connection Diagrams**

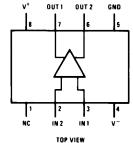
#### Metal Can Package



TI /H/5707-4

Order Number LM160H/883\* or LM360H See NS Package Number H08C

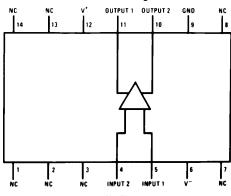
## **Dual-In-Line Package**



TL/H/5707-5

Order Number LM160J/883\*, LM360M or LM360N See NS Package Number J08A, M08A or N08E

### Dual-In-Package



TL/H/5707-6

Order Number LM160J-14/883\* See NS Package Number J14A

\*Also available in SMD# 5962-8767401

## **Absolute Maximum Ratings** (Note 5)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

(Note 7)

+8VPositive Supply Voltage Negative Supply Voltage -8VPeak Output Current 20 mA Differential Input Voltage  $\pm\,5V$  $V^+ \geq V_{IN} \geq V^-$ Input Voltage 1600V

ESD Tolerance (Note 8)

Operating Temperature Range

LM160 -55°C to +125°C LM360 0°C to +70°C

-65°C to +150°C Storage Temperature Range 260°C

Lead Temperature (Soldering, 10 sec.)

Soldering Information Dual-In-Line Package

Soldering (10 seconds) 260°C

Small Outline Package

Vapor Phase (60 seconds) 215°C Infrared (15 seconds) 220°C

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

165°C/W

67°C/W

25°C/W

(Still Air)

(400 LF/min Air Flow)

## **Electrical Characteristics** $(T_{MIN} \le T_A \le T_{MAX})$

Parameter	Conditions	Min	Тур	Max	Units
Operating Conditions Supply Voltage V <sub>CC</sub> <sup>+</sup> Supply Voltage V <sub>CC</sub> <sup>-</sup>		4.5 4.5	5 -5	6.5 6.5	V V
Input Offset Voltage	$R_S \le 200\Omega$		2	5	mV
Input Offset Current			0.5	3	μΑ
Input Bias Current			5	20	μΑ
Output Resistance (Either Output)	$V_{OUT} = V_{OH}$		100		Ω
Response Time	$T_A = 25^{\circ}\text{C}, V_S = \pm 5\text{V (Notes 1, 6)}$ $T_A = 25^{\circ}\text{C}, V_S = \pm 5\text{V (Notes 2, 6)}$ $T_A = 25^{\circ}\text{C}, V_S = \pm 5\text{V (Notes 3, 6)}$		13 12 14	25 20	ns ns ns
Response Time Difference between Outputs	$T_A = 25^{\circ}\text{C (Notes 1, 6)}$ $T_A = 25^{\circ}\text{C (Notes 1, 6)}$ $T_A = 25^{\circ}\text{C (Notes 1, 6)}$ $T_A = 25^{\circ}\text{C (Notes 1, 6)}$		2 2 2 2		ns ns ns ns
Input Resistance	f = 1 MHz		17		kΩ
Input Capacitance	f = 1 MHz		3		pF
Average Temperature Coefficient of Input Offset Voltage	$R_S = 50\Omega$		8		μV/°C
Average Temperature Coefficient of Input Offset Current			7		nA/°C
Common Mode Input Voltage Range	$V_S = \pm 6.5V$	±4	±4.5		V
Differential Input Voltage Range		±5			V
Output High Voltage (Either Output)	$I_{OUT} = -320 \mu\text{A}, V_{S} = \pm 4.5 \text{V}$	2.4	3		V
Output Low Voltage (Either Output)	I <sub>SINK</sub> = 6.4 mA		0.25	0.4	V
Positive Supply Current	$V_S = \pm 6.5V$		18	32	mA
Negative Supply Current	V <sub>S</sub> = ±6.5V		-9	-16	mA

 $\textbf{Note 1:} \ \text{Response time measured from the 50\% point of a 30 mVp-p 10 MHz sinusoidal input to the 50\% point of the output.}$ 

Note 2: Response time measured from the 50% point of a 2 Vp-p 10 MHz sinusoidal input to the 50% point of the output.

Note 3: Response time measured from the start of a 100 mV input step with 5 mV overdrive to the time when the output crosses the logic threshold.

Note 4: Typical thermal impedances are as follows: Cavity DIP (J): 135°C/W  $\theta_{\mathsf{jA}}$ 

Molded DIP (N):

 $\theta_{jA}$ 

Note 5: The device may be damaged if used beyond the maximum ratings. Note 6: Measurements are made in AC Test Circuit, Fanout = 1

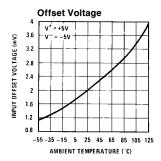
Note 7: Refer to RETS 160X for LM160H, LM160J-14 and LM160J military specifications.

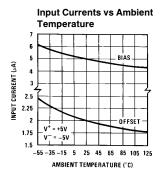
130°C/W

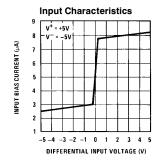
Note 8: Human body model, 1.5  $k\Omega$  in series with 100 pF.

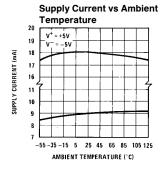
Header (H)

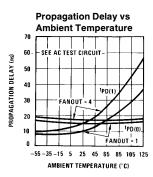
# **Typical Performance Characteristics**

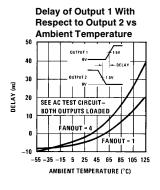


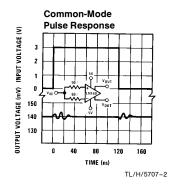


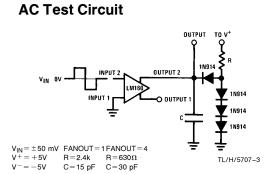


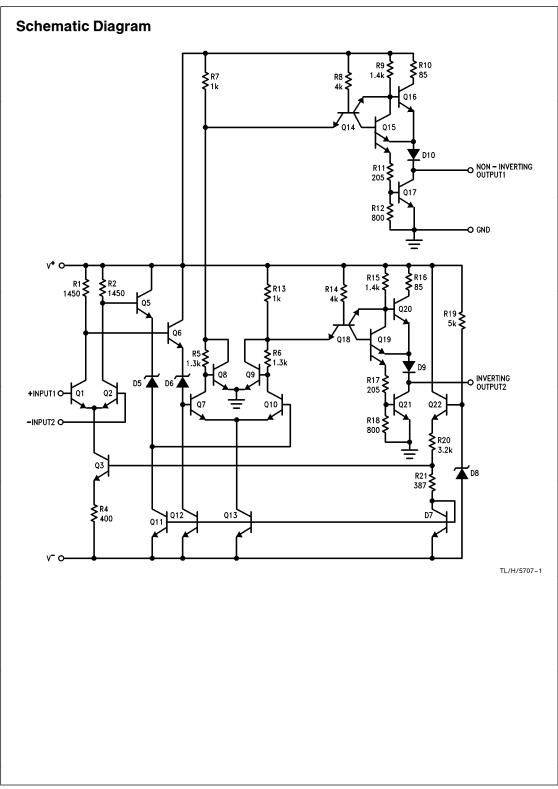


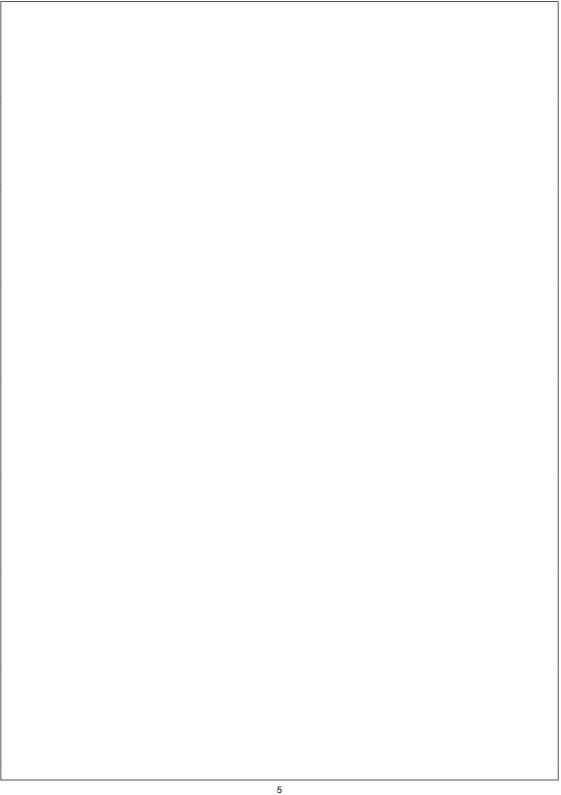


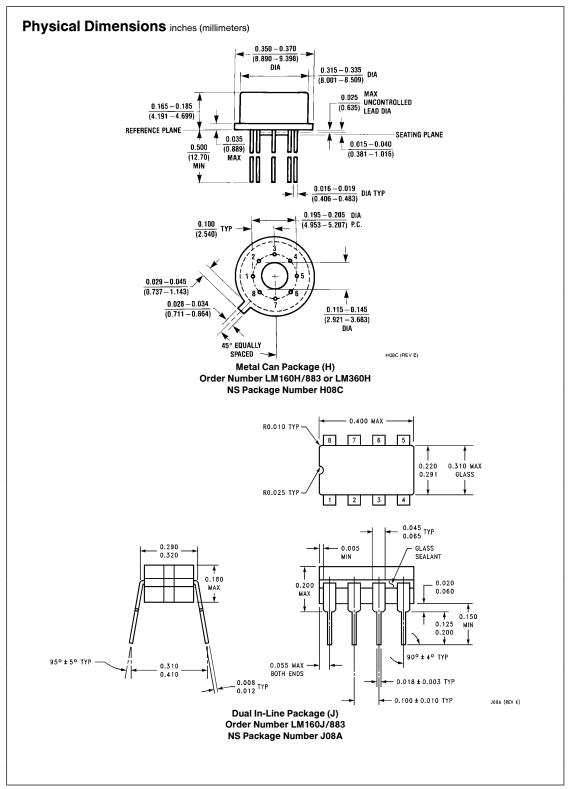




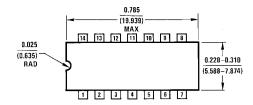


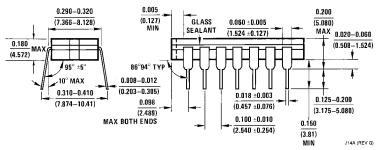




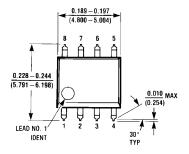


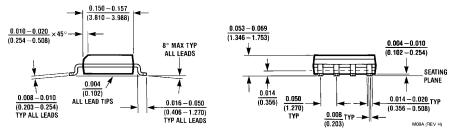
## Physical Dimensions inches (millimeters) (Continued)





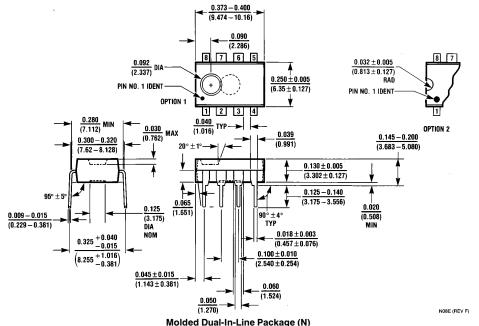
Ceramic Dual-In-Line Package (J) Order Number LM160J-14/883 NS Package Number J14A





Molded Dual-In-Line Package (M) Order Number LM360M NS Package Number M08A

# Physical Dimensions inches (millimeters) (Continued)



Molded Dual-In-Line Package (N) Order Number LM360N NS Package Number N08E

#### LIFE SUPPORT POLICY

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



National Semiconductor Corporation 1111 West Bardin Road Arlington, TX 76017 Tel: 1(800) 272-9959 Fax: 1(800) 737-7018 National Semiconductor Europe

Fax: (+49) 0-180-530 85 86 Email: onlyeg@tevnz.nsc.com
Deutsch Tel: (+49) 0-180-530 85 85 English Tel: (+49) 0-180-532 78 32 Français Tel: (+49) 0-180-532 93 58 Italiano Tel: (+49) 0-180-534 16 80

National Semiconductor Hong Kong Ltd. 13th Floor, Straight Block, Ocean Centre, 5 Canton Rd. Tsimshatsui, Kowloon Hong Kong Tel: (852) 2737-1600 Fax: (852) 2736-9960 National Semiconductor Japan Ltd. Tel: 81-043-299-2309 Fax: 81-043-299-2408 This datasheet has been download from:

www.datasheetcatalog.com

Datasheets for electronics components.